

### Notes:

1: Current is limited by bondwire configuration.

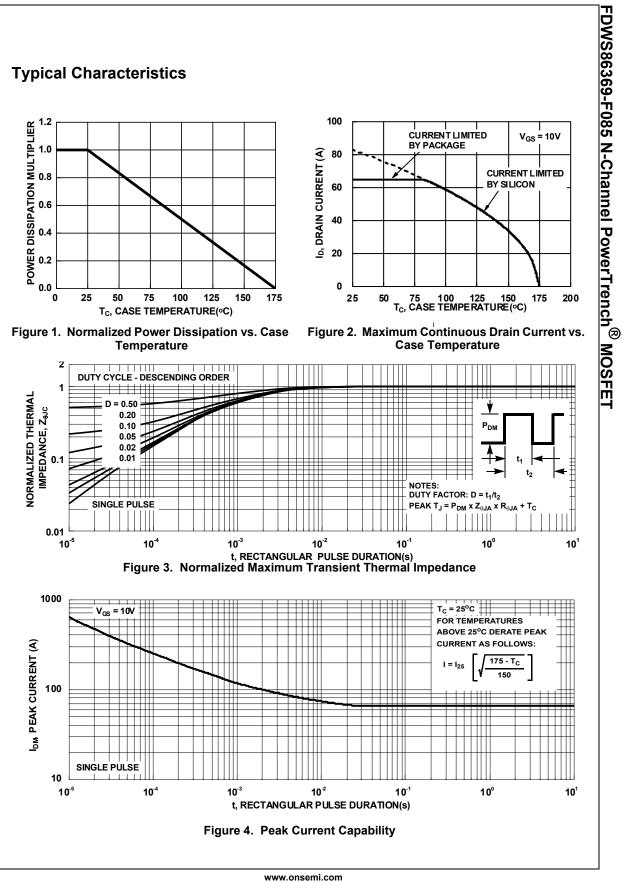
2: Starting T<sub>J</sub> = 25°C, L = 20uH, I<sub>AS</sub> = 52A, V<sub>DD</sub> = 80V during inductor charging and V<sub>DD</sub> = 0V during time in avalanche.

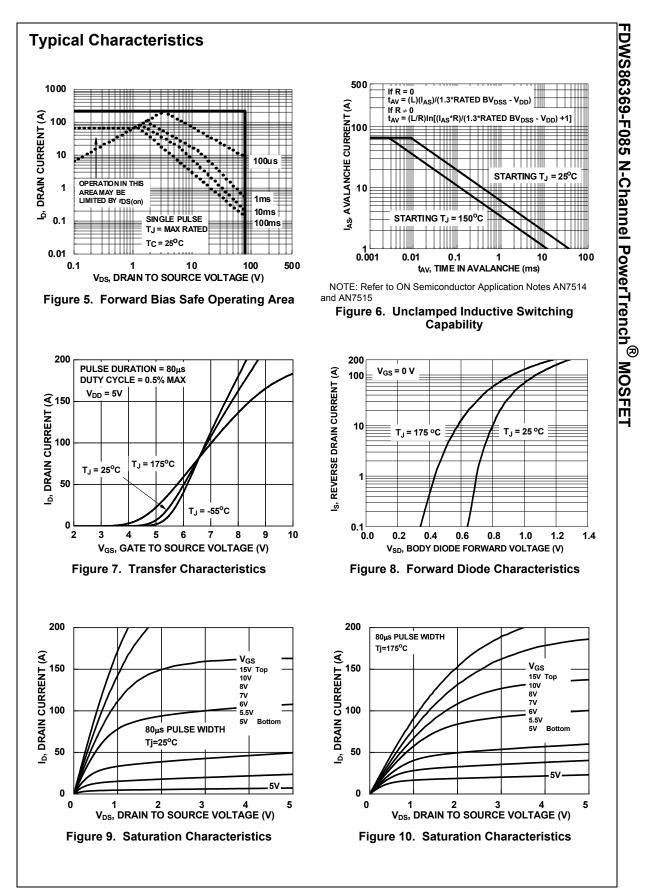
3: R<sub>0JA</sub> is the sum of the junction-to-case and case-to-ambient thermal resistance, where the case thermal reference is defined as the solder mounting surface of the drain pins. R<sub>0JC</sub> is guaranteed by design, while R<sub>0JA</sub> is determined by the board design. The maximum rating presented here is based on mounting on a 1 in<sup>2</sup> pad of 2oz copper.

## Package Marking and Ordering Information

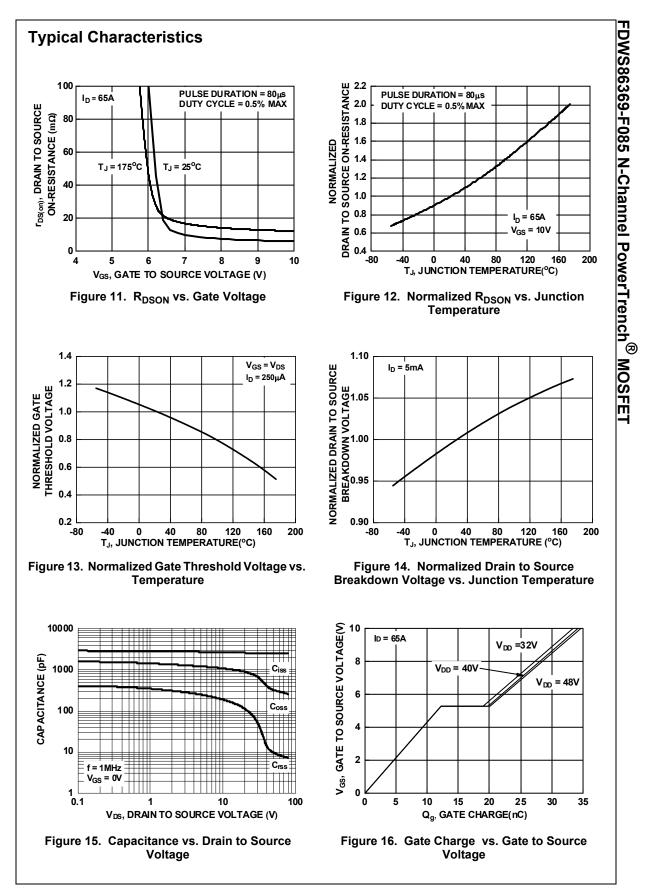
Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDWS86369	FDWS86369-F085	Power56	13"	12mm	3000units

Symbol	Parameter	Test Conditions			Тур.	Max.	Units
Off Cha	racteristics						
B <sub>VDSS</sub>	Drain-to-Source Breakdown Voltage	I <sub>D</sub> = 250μA, V <sub>GS</sub> = 0V		80	-	-	V
I <sub>DSS</sub>		V <sub>DS</sub> =80V		-	-	1	μA
	Drain-to-Source Leakage Current	$V_{GS} = 0V$	T <sub>J</sub> = 175 <sup>o</sup> C (Note 4)	-	-	1	mA
I <sub>GSS</sub>	Gate-to-Source Leakage Current	$V_{GS} = \pm 20V$		-	-	±100	nA
On Cha	racteristics						
V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	V <sub>GS</sub> = V <sub>DS</sub> , I <sub>D</sub> = 250μA		2	3	4	V
Back	Drain to Source On Resistance	I <sub>D</sub> = 65A,	T <sub>J</sub> = 25 <sup>o</sup> C	-	5.9	7.5	mΩ
R <sub>DS(on)</sub>	Drain to Source On Resistance	V <sub>GS</sub> = 10V	T <sub>J</sub> = 175 <sup>o</sup> C (Note 4	) –	12.2	15.5	mΩ
Dynami	ic Characteristics						
C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> = 40V, V <sub>GS</sub> = 0V, f = 1MHz		-	2470	-	pF
C <sub>oss</sub>	Output Capacitance			-	400	-	pF
C <sub>rss</sub>	Reverse Transfer Capacitance			-	14	-	pF
R <sub>g</sub>	Gate Resistance	f = 1MHz		-	1.8	-	Ω
Q <sub>g(ToT)</sub>	Total Gate Charge	V <sub>GS</sub> = 0 to 1	0V V <sub>DD</sub> = 64V	-	35	46	nC
Q <sub>g(th)</sub>	Threshold Gate Charge	V <sub>GS</sub> = 0 to 2	V I <sub>D</sub> = 65A	-	4.5	-	nC
Q <sub>gs</sub>	Gate-to-Source Gate Charge			-	12.5	-	nC
Q <sub>gd</sub>	Gate-to-Drain "Miller" Charge			-	8	-	nC
	ng Characteristics			-	-	39	ns
t <sub>on</sub> t <sub>d(on)</sub>	Turn-On Delay	$V_{DD}$ = 40V, I <sub>D</sub> = 65A, $V_{GS}$ = 10V, R <sub>GEN</sub> = 6 $\Omega$		-	15		ns
t <sub>r</sub>	Rise Time			-	10	-	ns
t <sub>d(off)</sub>	Turn-Off Delay			-	24	-	ns
t <sub>f</sub>	Fall Time			-	8	-	ns
t <sub>off</sub>	Turn-Off Time		-	-	48	ns	
-	ource Diode Characteristics	<b>I</b>		1	1	I	
	Source-to-Drain Diode Voltage	I <sub>SD</sub> =65A, V <sub>GS</sub> = 0V		-	-	1.4	V
Ven	-	I <sub>SD</sub> = 32.5A, V <sub>GS</sub> = 0V		-	-	1.2	V
		$I_{F} = 65A, dI_{SD}/dt = 100A/\mu s$		-	49	74	ns
V <sub>SD</sub> t <sub>rr</sub> Q <sub>rr</sub>	Reverse-Recovery Time Reverse-Recovery Charge	V <sub>DD</sub> = 64V			44	68	nC

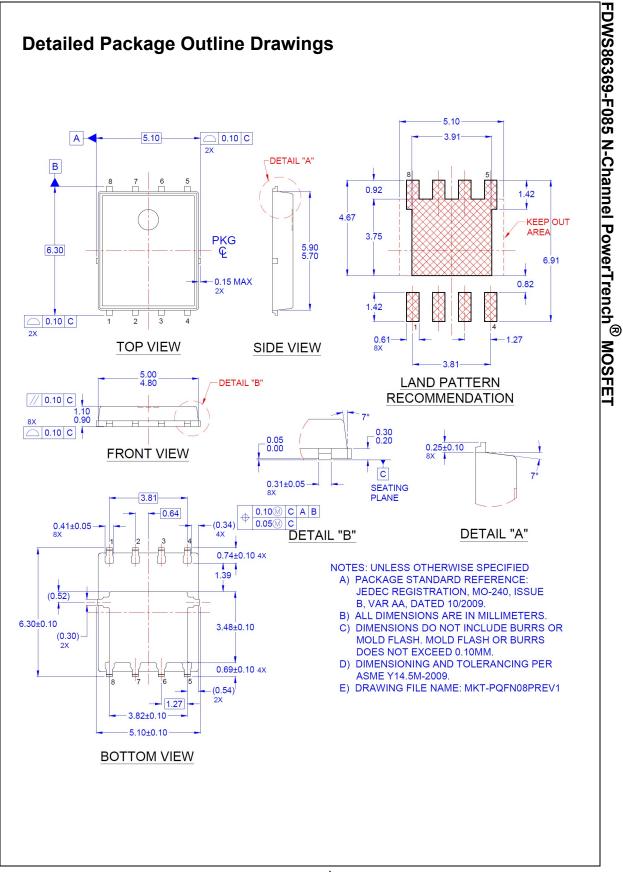




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